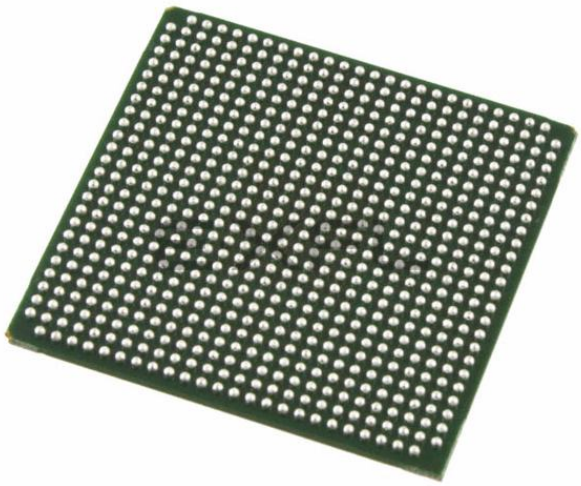

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

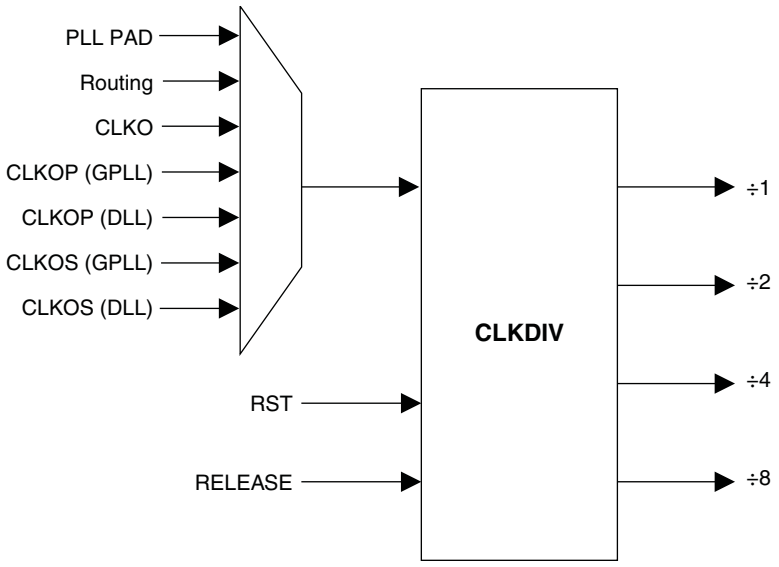
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	402
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20se-5f672i

Figure 2-9. Clock Divider Connections



Clock Distribution Network

LatticeECP2/M devices have eight quadrant-based primary clocks and eight flexible region-based secondary clocks/control signals. Two high performance edge clocks are available on each edge of the device to support high speed interfaces. These clock inputs are selected from external I/Os, the sysCLOCK PLLs, DLLs or routing. These clock inputs are fed throughout the chip via a clock distribution system.

Primary Clock Sources

LatticeECP2/M devices derive clocks from five primary sources: PLL (GPLL and SPLL) outputs, DLL outputs, CLKDIV outputs, dedicated clock inputs and routing. LatticeECP2/M devices have two to eight sysCLOCK PLLs and two DLLs, located on the left and right sides of the device. There are eight dedicated clock inputs, two on each side of the device, with the exception of the LatticeECP2M 256-fpBGA package devices which have six dedicated clock inputs on the device. Figure 2-10 shows the primary clock sources.

O standards (together with their supply and reference voltages) supported by LatticeECP2/M devices. For further information about utilizing the sysI/O buffer to support a variety of standards please see the the list of additional technical information at the end of this data sheet.

Table 2-13. Supported Input Standards

Input Standard	V_{REF} (Nom.)	V_{CCIO}[1] (Nom.)
Single Ended Interfaces		
LVTTL	—	—
LVCMOS33	—	—
LVCMOS25	—	—
LVCMOS18	—	1.8
LVCMOS15	—	1.5
LVCMOS12	—	—
PCI 33	—	3.3
HSTL18 Class I, II	0.9	—
HSTL15 Class I	0.75	—
SSTL3 Class I, II	1.5	—
SSTL2 Class I, II	1.25	—
SSTL18 Class I, II	0.9	—
Differential Interfaces		
Differential SSTL18 Class I, II	—	—
Differential SSTL2 Class I, II	—	—
Differential SSTL3 Class I, II	—	—
Differential HSTL15 Class I	—	—
Differential HSTL18 Class I, II	—	—
LVDS, MLVDS, LVPECL, BLVDS, RSDS	—	—

1 When not specified, V_{CCIO} can be set anywhere in the valid operating range (page 3-1).

for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm ±1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5[1]	13.0	45.0	2.5[1]
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

RSDS

The LatticeECP2/M devices support differential RSDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The RSDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-4 is one possible solution for RSDS standard implementation. Resistor values in Figure 3-4 are industry standard values for 1% resistors.

Figure 3-4. RSDS (Reduced Swing Differential Signaling)

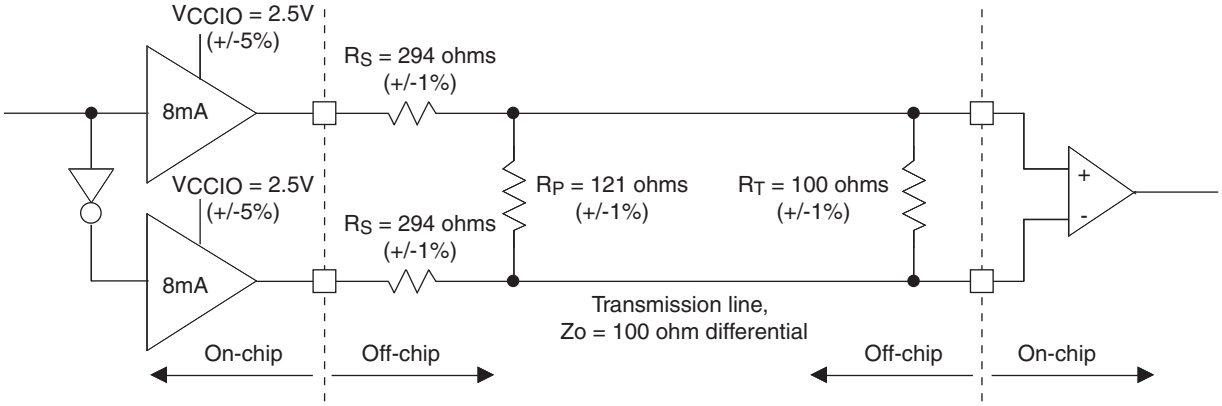


Table 3-5. RSDS DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
V_{CCIO}	Output Driver Supply (+/-5%)	2.50	V
Z_{OUT}	Driver Impedance	20	Ω
R_S	Driver Series Resistor (+/-1%)	294	Ω
R_P	Driver Parallel Resistor (+/-1%)	121	Ω
R_T	Receiver Termination (+/-1%)	100	Ω
V_{OH}	Output High Voltage	1.35	V
V_{OL}	Output Low Voltage	1.15	V
V_{OD}	Output Differential Voltage	0.20	V
V_{CM}	Output Common Mode Voltage	1.25	V
Z_{BACK}	Back Impedance	101.5	Ω
I_{DC}	DC Output Current	3.66	mA

1. For input buffer, see LVDS table.

LatticeECP2/M Internal Switching Characteristics[1]

Over Recommended Operating Conditions

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
PFU/PFF Logic Mode Timing								
t_{LUT4_PFU}	LUT4 delay (A to D inputs to F output)	—	0.180	—	0.198	—	0.216	ns
t_{LUT6_PFU}	LUT6 delay (A to D inputs to OFX output)	—	0.304	—	0.331	—	0.358	ns
t_{LSR_PFU}	Set/Reset to output of PFU (Asynchronous)	—	0.600	—	0.655	—	0.711	ns
t_{SUM_PFU}	Clock to Mux (M0,M1) Input Setup Time	0.128	—	0.129	—	0.129	—	ns
t_{HM_PFU}	Clock to Mux (M0,M1) Input Hold Time	-0.051	—	-0.049	—	-0.046	—	ns
t_{SUD_PFU}	Clock to D input setup time	0.061	—	0.071	—	0.081	—	ns
t_{HD_PFU}	Clock to D input hold time	0.002	—	0.003	—	0.003	—	ns
t_{CK2Q_PFU}	Clock to Q delay, (D-type Register Configuration)	—	0.285	—	0.309	—	0.333	ns
PFU Dual Port Memory Mode Timing								
t_{CORAM_PFU}	Clock to Output (F Port)	—	0.902	—	1.083	—	1.263	ns
t_{SUDATA_PFU}	Data Setup Time	-0.172	—	-0.205	—	-0.238	—	ns
t_{HDATA_PFU}	Data Hold Time	0.199	—	0.235	—	0.271	—	ns
t_{SUADDR_PFU}	Address Setup Time	-0.245	—	-0.284	—	-0.323	—	ns
t_{HADDR_PFU}	Address Hold Time	0.246	—	0.285	—	0.324	—	ns
t_{SUWREN_PFU}	Write/Read Enable Setup Time	-0.122	—	-0.145	—	-0.168	—	ns
t_{HWREN_PFU}	Write/Read Enable Hold Time	0.132	—	0.156	—	0.180	—	ns
PIC Timing								
PIO Input/Output Buffer Timing								
t_{IN_PIO}	Input Buffer Delay (LVCMOS25)	—	0.613	—	0.681	—	0.749	ns
t_{OUT_PIO}	Output Buffer Delay (LVCMOS25)	—	1.115	—	1.115	—	1.343	ns
IOLOGIC Input/Output Timing								
t_{SUI_PIO}	Input Register Setup Time (Data Before Clock)	0.596	—	0.645	—	0.694	—	ns
t_{HI_PIO}	Input Register Hold Time (Data after Clock)	-0.570	—	-0.614	—	-0.658	—	ns
t_{COO_PIO}	Output Register Clock to Output Delay	—	0.61	—	0.66	—	0.72	ns
t_{SUCE_PIO}	Input Register Clock Enable Setup Time	0.032	—	0.037	—	0.041	—	ns
t_{HCE_PIO}	Input Register Clock Enable Hold Time	-0.022	—	-0.025	—	-0.028	—	ns
t_{SULSR_PIO}	Set/Reset Setup Time	0.184	—	0.201	—	0.217	—	ns
t_{HLSR_PIO}	Set/Reset Hold Time	-0.080	—	-0.086	—	-0.093	—	ns
EBR Timing								
t_{CO_EBR}	Clock (Read) to output from Address or Data	—	2.51	—	2.75	—	2.99	ns
t_{COO_EBR}	Clock (Write) to output from EBR output Register	—	0.33	—	0.36	—	0.39	ns
t_{SUDATA_EBR}	Setup Data to EBR Memory	-0.157	—	-0.181	—	-0.205	—	ns
t_{HDATA_EBR}	Hold Data to EBR Memory	0.173	—	0.195	—	0.217	—	ns
t_{SUADDR_EBR}	Setup Address to EBR Memory	-0.115	—	-0.130	—	-0.145	—	ns
t_{HADDR_EBR}	Hold Address to EBR Memory	0.138	—	0.155	—	0.172	—	ns
t_{SUWREN_EBR}	Setup Write/Read Enable to PFU Memory	-0.128	—	-0.149	—	-0.170	—	ns

sysCLOCK SPLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)	Without external capacitor	33	—	420	MHz
		With external capacitor[5, 6]	2	—	420	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)	Without external capacitor	33	—	420	MHz
		With external capacitor[5]	5	—	50	MHz
f_{OUT2}	K-Divider Output Frequency (CLKOK)	Without external capacitor	0.258	—	210	MHz
		With external capacitor[5]	0.039	—	25	MHz
f_{VCO}	PLL VCO Frequency		640	—	1280	MHz
f_{PFD}	Phase Detector Input Frequency	Without external capacitor	33	—	420	MHz
		With external capacitor[6]	2	—	50	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default Duty Cycle Selected[3]	45	50	55	%
t_{PH}[4]	Output Phase Accuracy		—	—	±0.05	UI
t_{OPJIT}[1]	Output Clock Period Jitter	$f_{OUT} \geq 100$ MHz	—	—	±125	ps
		$50 \leq f_{OUT} < 100$ MHz	—	—	0.025	UIPP
		$f_{OUT} < 50$ MHz	—	—	0.04	UIPP
t_{SK}	Input Clock to Output Clock Skew	Divider Ratio = Integer	—	—	±250	ps
t_W	Output Clock Pulse Width	At 90% or 10%	1	—	—	ns
t_{LOCK}[2]	PLL Lock-in Time	Without external capacitor	—	—	150	µs
		With external capacitor[5]	—	—	500	µs
t_{IPJIT}	Input Clock Period Jitter		—	—	±200	ps
t_{FBKDLY}	External Feedback Delay		—	—	10	ns
t_{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t_{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t_{RST}	RST Pulse Width (RSTK)		15	—	—	ns
	Reset Signal Pulse Width (RST)	Without external capacitor	500	—	—	ns
		With external capacitor[5]	20	—	—	µs

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.
2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.
3. Using LVDS output buffers.
4. Phase accuracy of CLKOS compared to CLKOP.
5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.
6. f_{OUT} (max) = f_{IN} * 10 for f_{IN} < 5MHz.

SERDES High Speed Data Receiver (LatticeECP2M Family Only)

Table 3-11. Serial Input Data Specifications

Symbol	Description	Min.	Typ.	Max.	Units
$RX\text{-}CID_S$	Stream of nontransitions[1] (CID = Consecutive Identical Digits) @ 10^{-12} BER		7 @ 3.125 Gbps 20 @ 1.25 Gbps		Bits
$V_{RX\text{-}DIFF\text{-}S}$	Differential input sensitivity	100	—	—	mV, p-p
$V_{RX\text{-}IN}$	Input levels	0	—	V_{CCRX} + 0.8	V
$V_{RX\text{-}CM\text{-}DC}$	Input common mode range (DC coupled)	0.5	—	1.2	V
$V_{RX\text{-}CM\text{-}AC}$	Input common mode range (AC coupled)[3]	0	—	1.5	V
$T_{RX\text{-}RELOCK}$	CDR re-lock time[2]	—	—	3000	Bits
$Z_{RX\text{-}TERM}$	Input termination 50/75 Ohm/High Z	—	50		Ohms
$RL_{RX\text{-}RL}$	Return loss (without package)	—	9	—	dB

1. This is the number of bits allowed without a transition on the incoming data stream when using DC coupling.
2. This is the typical number of bit times to re-lock to a new phase of frequency within +/- 300 ppm, assuming 8b10b encoded data and the CDR is in lock state. When CDR is in un-lock state, or reset is applied, the total re-lock settling time will be approximately 4ms including analog settle time, calibration time, and acquisition time.
3. AC coupling is used to interface to LVPECL and LVDS.

Input Data Jitter Tolerance

A receiver's ability to tolerate incoming signal jitter is very dependent on jitter type. High speed serial interface standards have recognized the dependency on jitter type and have recently modified specifications to indicate tolerance levels for different jitter types as they relate to specific protocols (e.g. FC, etc.). Sinusoidal jitter is considered to be a worst case jitter type.

Table 3-12. Receiver Total Jitter Tolerance Specification[1]

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	600 mV differential eye	—	—	0.54	UI, p-p
Random		600 mV differential eye	—	—	0.26	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	2.5 Gbps	600 mV differential eye	—	—	0.61	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.81	UI, p-p
Deterministic	1.25 Gbps	600 mV differential eye	—	—	0.53	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	250 Mbps[2]	600 mV differential eye	—	—	0.42	UI, p-p
Random		600 mV differential eye	—	—	0.10	UI, p-p
Total		600 mV differential eye	—	—	0.60	UI, p-p

1. Values are measured with PRBS 2^7-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, voltages are nominal, room temperature.
2. Jitter specification is limited by measurement equipment capability.

LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35 (Cont.)

Pin Type		LFE2-20				LFE2-35	
		208 PQFP	256 fpBGA	484 fpBGA	672 fpBGA	484 fpBGA	672 fpBGA
Available DDR-Interfaces per I/O Bank[1]	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	1	2	2	2	3
	Bank3	0	0	0	2	0	2
	Bank4	0	2	3	3	3	3
	Bank5	0	1	3	4	3	4
	Bank6	0	1	2	3	1	3
	Bank7	0	1	2	2	2	3
	Bank8	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	0	0	0	0	0
	Bank3	0	0	0	0	0	0
	Bank4	19	32	46	50	46	54
	Bank5	18	17	46	68	46	68
	Bank6	0	0	0	0	0	0
	Bank7	0	0	0	0	0	0
	Bank8	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2M Power Supply and NC (Cont.)

Signal	1152 fpBGA
V_{CC}	AA13, AA14, AA15, AA16, AA17, AA18, AA19, AA20, AA21, AA22, AB14, AB15, AB20, AB21, N14, N15, N20, N21, P13, P14, P15, P16, P17, P18, P19, P20, P21, P22, R13, R14, R21, R22, T14, T21, U14, U21, V14, V21, W14, W21, Y13, Y14, Y21, Y22
V_{CCIO0}	C12, C16, E14, H12, H16, M14, M15
V_{CCIO1}	C19, C23, E21, H19, H23, M20, M21
V_{CCIO2}	G32, K28, K32, N27, N32, P23, R23, T27, T32
V_{CCIO3}	AA23, AB27, AB32, AE28, AE32, AH32, W27, W32, Y23
V_{CCIO4}	AC20, AC21, AG19, AG23, AK21, AM19, AM23
V_{CCIO5}	AC14, AC15, AG12, AG16, AK14, AM12, AM16
V_{CCIO6}	AA12, AB3, AB8, AE3, AE7, AH3, W3, W8, Y12
V_{CCIO7}	G3, K3, K7, N3, N8, P12, R12, T3, T8
V_{CCIO8}	AD28, AG32
V_{CCJ}	AK3
V_{CCAUX}	AB12, AB13, AB22, AB23, AC13, AC22, M13, M22, N12, N13, N22, N23
V_{CCPLL}	R15, R20, Y15, Y20
SERDES Power[3]	D7, B9, B8, D9, B7, E7, B6, D8, E6, D6, D4, B5, D3, B4, C1, B3, B1, B2, B33, B34, B32, C34, B31, D32, B30, D31, E29, D29, D27, B29, E28, B28, D26, B27, B26, D28, AL28, AN26, AN27, AL26, AN28, AK28, AN29, AL27, AL29, AK29, AL31, AN30, AL32, AN31, AM34, AN32, AN34, AN33, AN2, AN1, AN3, AM1, AN4, AL3, AN5, AL4, AL6, AK6, AL8, AN6, AK7, AN7, AL9, AN8, AN9, AL7
GND[1]	A1, A10, A13, A22, A25, A34, AB16, AB17, AB18, AB19, AB26, AB31, AB4, AB9, AC16, AC17, AC18, AC19, AD27, AE27, AE31, AE4, AE8, AF12, AF16, AF19, AF23, AG31, AH31, AH4, AJ14, AJ21, AK27, AK8, AL10, AL16, AL19, AL2, AL25, AL33, AP1, AP10, AP13, AP22, AP25, AP34, D10, D16, D19, D2, D25, D33, E27, E8, F14, F21, G31, G4, J12, J16, J19, J23, K27, K31, K4, K8, M16, M17, M18, M19, N16, N17, N18, N19, N26, N31, N4, N9, R16, R17, R18, R19, T12, T13, T15, T16, T17, T18, T19, T20, T22, T23, T26, T31, T4, T9, U12, U13, U15, U16, U17, U18, U19, U20, U22, U23, V12, V13, V15, V16, V17, V18, V19, V20, V22, V23, W12, W13, W15, W16, W17, W18, W19, W20, W22, W23, W26, W31, W4, W9, Y16, Y17, Y18, Y19
NC[2]	**LFE2M70:** H2, H1, G5, G6, M9, M10, H3, H4, P3, P4, P9, M7, P1, P2, N7, P7, AC7, AC5, AC6, AD5, AD4, AD3, AD10, AD8, AD2, AD1, AD9, AC11, AD6, AD7, AE1, AE2, AJ12, AH12, AL13, AK13, AE14, AG13, AH22, AH21, AG22, AG21, AF33, AF34, AC27, AC28, AD29, AD30, AE33, AE34, AD32, AD31, AB25, AC25, AB28, AA26, AD33, AD34, P30, P29, P31, P32, R25, T24, N34, N33, F24, G23, J22, G22, H21, K21, L19, L20, L18, K19, J14, L15, H14, K14, F12, D11, F11, E11, A11, A12, A23, A24, AA11, AB11, AC26, AC30, AD11, AD12, AD13, AD14, AD15, AD19, AD21, AD22, AD23, AE10, AE11, AE12, AE13, AE19, AE21, AE22, AE23, AF11, AF21, AF22, AF24, AF8, AF9, AG10, AG11, AG24, AG25, AG26, AG3, AG7, AG8, AG9, AH10, AH11, AH13, AH24, AH25, AH26, AH27, AH5, AH6, AH7, AH8, AH9, AJ10, AJ11, AJ13, AJ24, AJ25, AJ26, AJ27, AJ3, AJ4, AJ5, AJ6, AJ7, AJ8, AJ9, AK10, AK11, AK12, AK24, AK25, AK26, AK4, AK9, AL11, AL12, AL34, AM10, AM11, AM13, AM25, AN10, AN11, AN12, AN13, AN24, AN25, AP11, AP12, AP24, B10, B11, B12, B13, B22, B23, B24, B25, C10, C11, C13, C22, C24, C25, D1, D15, D24, D34, E10, E24, E25, E26, E3, E31, E32, E33, E34, E4, E9, F10, F25, F26, F27, F28, F29, F30, F31, F32, F33, F34, F5, F6, F7, F8, F9, G10, G11, G24, G25, G26, G27, G28, G29, G30, G33, G34, G7, G8, G9, H10, H11, H24, H25, H26, H27, H28, H29, H8, H9, J10, J11, J24, J25, J26, J9, K10, K11, K12, K13, K23, K24, K25, K26, L11, L12, L13, L14, L21, L22, L23, L24, L25, L26, M11, M24, M25, M6, M8, N10, N11, P10, P25, P26, R9, T11, U11, W11, Y10, Y11 **LFE2M100:** A11, A12, A23, A24, AA11, AB11, AC26, AC30, AD11, AD12, AD13, AD14, AD15, AD19, AD21, AD22, AD23, AE10, AE11, AE12, AE13, AE19, AE21, AE22, AE23, AF11, AF21, AF22, AF24, AF8, AF9, AG10, AG11, AG24, AG25, AG26, AG3, AG7, AG8, AG9, AH10, AH11, AH13, AH24, AH25, AH26, AH27, AH5, AH6, AH7, AH8, AH9, AJ10, AJ11, AJ13, AJ24, AJ25, AJ26, AJ27, AJ3, AJ4, AJ5, AJ6, AJ7, AJ8, AJ9, AK10, AK11, AK12, AK24, AK25, AK26, AK4, AK9, AL11, AL12, AL34, AM10, AM11, AM13, AM25, AN10, AN11, AN12, AN13, AN24, AN25, AP11, AP12, AP24, B10, B11, B12, B13, B22, B23, B24, B25, C10, C11, C13, C22, C24, C25, D1, D15, D24, D34, E10, E24, E25, E26, E3, E31, E32, E33, E34, E4, E9, F10, F25, F26, F27, F28, F29, F30, F31, F32, F33, F34, F5, F6, F7, F8, F9, G10, G11,G24, G25, G26, G27, G28, G29, G30, G33, G34, G7, G8, G9, H10, H11, H24, H25, H26, H27, H28, H29, H8, H9, J10, J11, J24, J25, J26, J9, K10, K11, K12, K13, K23, K24, K25, K26, L11, L12, L13, L14, L21, L22, L23, L24, L25, L26, M11, M24, M25, M6, M8, N10, N11, P10, P25, P26, R9, T11, U11, W11, Y10, Y11

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, LatticeECP2/M Density Migration for more details.

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
A5	A5	PT36B	0		C
A3	A3	PT35B	0		C
A4	A4	PT36A	0		T
VCCIO	VCCIO	VCCIO0	0		
B3	B3	PT35A	0		T
A2	A2	PT34B	0		C
C7	C7	PT33B	0		C
B2	B2	PT34A	0		T
D7	D7	PT33A	0		T
D6	D6	PT32B	0		C
GND	GND	GNDIO0	-		
F7	F7	PT31B	0		C
C6	C6	PT32A	0		T
VCCIO	VCCIO	VCCIO0	0		
F6	F6	PT31A	0		T
C4	C4	PT30B	0		C
B4	B4	PT30A	0		T
-	GND	GNDIO0	0		
-	VCC	VCCIO	0		
D5	D5	PT2B	0	VREF2_0	C
E5	E5	PT2A	0	VREF1_0	T
G7	G7	VCC	-		
G9	G9	VCC	-		
H7	H7	VCC	-		
J10	J10	VCC	-		
K10	K10	VCC	-		
K8	K8	VCC	-		
G8	G8	VCCAUX	-		
H10	H10	VCCAUX	-		
J7	J7	VCCAUX	-		
K9	K9	VCCAUX	-		
C5	C5	VCCIO0	0		
E7	E7	VCCIO0	0		
C12	C12	VCCIO1	1		
E10	E10	VCCIO1	1		
E14	E14	VCCIO2	2		
G12	G12	VCCIO2	2		
K12	K12	VCCIO3	3		
M14	M14	VCCIO3	3		
M10	M10	VCCIO4	4		
P12	P12	VCCIO4	4		
M7	M7	VCCIO5	5		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AB7	PB13B	5	BDQ15	C	PB22B	5	BDQ24	C
Y8	PB16A	5	BDQ15	T	PB25A	5	BDQ24	T
GNDIO	GNDIO5	-			GNDIO	-		
W9	PB15A	5	BDQS15	T	PB24A	5	BDQS24	T
AA8	PB16B	5	BDQ15	C	PB25B	5	BDQ24	C
V9	PB15B	5	BDQ15	C	PB24B	5	BDQ24	C
AB8	PB18A	5	BDQ15	T	PB27A	5	BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		
W10	PB17A	5	BDQ15	T	PB26A	5	BDQ24	T
AA9	PB18B	5	BDQ15	C	PB27B	5	BDQ24	C
V10	PB17B	5	BDQ15	C	PB26B	5	BDQ24	C
GNDIO	GNDIO5	-			GNDIO	-		
Y10	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
AB9	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
AA10	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AB10	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
AB11	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T
U10	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO5	5		
AA11	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C
U11	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C
GNDIO	GNDIO5	-			GNDIO5	-		
AB12	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T
Y11	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T
AA12	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C
W11	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C
AB13	PB26A	5	PCLKT5_0/BDQ24	T	PB35A	5	PCLKT5_0/BDQ33	T
VCCIO	VCCIO5	5			VCCIO5	5		
AB14	PB26B	5	PCLKC5_0/BDQ24	C	PB35B	5	PCLKC5_0/BDQ33	C
GNDIO	GNDIO5	-			GNDIO5	-		
Y12	PB32A	4	BDQ33	T	PB41A	4	BDQ42	T
W12	PB32B	4	BDQ33	C	PB41B	4	BDQ42	C
VCCIO	VCCIO4	4			VCCIO4	4		
U12	PB31A	4	PCLKT4_0/BDQ33	T	PB40A	4	PCLKT4_0/BDQ42	T
V12	PB31B	4	PCLKC4_0/BDQ33	C	PB40B	4	PCLKC4_0/BDQ42	C
U13	PB34A	4	BDQ33	T	PB43A	4	BDQ42	T
GNDIO	GNDIO4	-			GNDIO4	-		
AA13	PB33A	4	BDQS33	T	PB42A	4	BDQS42	T
U14	PB34B	4	BDQ33	C	PB43B	4	BDQ42	C
Y13	PB33B	4	BDQ33	C	PB42B	4	BDQ42	C
AB16	PB36A	4	BDQ33	T	PB45A	4	BDQ42	T
VCCIO	VCCIO4	4			VCCIO4	4		
AB15	PB35A	4	BDQ33	T	PB44A	4	BDQ42	T
AB17	PB36B	4	BDQ33	C	PB45B	4	BDQ42	C

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AA14	PB35B	4	BDQ33	C	PB44B	4	BDQ42	C
W13	PB37A	4	BDQ33	T	PB46A	4	BDQ42	T
GNDIO	GNDIO4	-			GNDIO4	-		
W14	PB37B	4	BDQ33	C	PB46B	4	BDQ42	C
AB18	PB39A	4	BDQ42	T	PB48A	4	BDQ51	T
AB19	PB39B	4	BDQ42	C	PB48B	4	BDQ51	C
Y15	PB41A	4	BDQ42	T	PB50A	4	BDQ51	T
V14	PB40A	4	BDQ42	T	PB49A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
AA15	PB41B	4	BDQ42	C	PB50B	4	BDQ51	C
W15	PB40B	4	BDQ42	C	PB49B	4	BDQ51	C
GNDIO	GNDIO4	-			GNDIO	-		
AB20	PB43A	4	BDQ42	T	PB52A	4	BDQ51	T
AA16	PB42A	4	BDQS42	T	PB51A	4	BDQS51	T
AB21	PB43B	4	BDQ42	C	PB52B	4	BDQ51	C
AA17	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C
Y16	PB45A	4	BDQ42	T	PB54A	4	BDQ51	T
U15	PB44A	4	BDQ42	T	PB53A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
W16	PB45B	4	BDQ42	C	PB54B	4	BDQ51	C
U16	PB44B	4	BDQ42	C	PB53B	4	BDQ51	C
AA18	PB46A	4	BDQ42	T	PB55A	4	BDQ51	T
AA20	PB46B	4	BDQ42	C	PB55B	4	BDQ51	C
GNDIO	GNDIO4	-			GNDIO	-		
V16	PB49A	4	BDQ51	T	PB58A	4	BDQ60	T
V17	PB49B	4	BDQ51	C	PB58B	4	BDQ60	C
AA21	PB48A	4	BDQ51	T	PB57A	4	BDQ60	T
VCCIO	VCCIO4	4			VCCIO4	4		
Y19	PB51A	4	BDQS51	T	PB60A	4	BDQS60	T
AA22	PB48B	4	BDQ51	C	PB57B	4	BDQ60	C
Y20	PB51B	4	BDQ51	C	PB60B	4	BDQ60	C
Y18	PB50A	4	BDQ51	T	PB59A	4	BDQ60	T
GNDIO	GNDIO4	-			GNDIO4	-		
Y21	PB53A	4	BDQ51	T	PB62A	4	BDQ60	T
Y17	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C
Y22	PB53B	4	BDQ51	C	PB62B	4	BDQ60	C
W17	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T
VCCIO	VCCIO4	4			VCCIO4	4		
U18	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T
W18	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C
V18	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C
GNDIO	GNDIO4	-			GNDIO4	-		
T15	PB55A	4	VREF2_4/BDQ51	T	PB64A	4	VREF2_4/BDQ60	T
T16	PB55B	4	VREF1_4/BDQ51	C	PB64B	4	VREF1_4/BDQ60	C

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
J22	PR29B	3	RDQ31	C (LVDS)*	PR48B	3	RDQ50	C (LVDS)*
H22	PR29A	3	RDQ31	T (LVDS)*	PR48A	3	RDQ50	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO	3		
M20	PR28B	3	VREF2_3/RDQ31	C	PR47B	3	VREF2_3/RDQ50	C
L21	PR28A	3	VREF1_3/RDQ31	T	PR47A	3	VREF1_3/RDQ50	T
K21	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*	PR46B	3	PCLKC3_0/RDQ50	C (LVDS)*
J21	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*	PR46A	3	PCLKT3_0/RDQ50	T (LVDS)*
M18	PR25B	2	PCLKC2_0/RDQ22	C	PR44B	2	PCLKC2_0/RDQ41	C
L17	PR25A	2	PCLKT2_0/RDQ22	T	PR44A	2	PCLKT2_0/RDQ41	T
GNDIO	GNDIO2	-			GNDIO2	-		
L19	PR24B	2	RDQ22	C (LVDS)*	PR43B	2	RDQ41	C (LVDS)*
L20	PR24A	2	RDQ22	T (LVDS)*	PR43A	2	RDQ41	T (LVDS)*
L18	PR23B	2	RDQ22	C	PR42B	2	RDQ41	C
K17	PR23A	2	RDQ22	T	PR42A	2	RDQ41	T
VCCIO	VCCIO2	2			VCCIO	2		
K18	PR22B	2	RDQ22	C (LVDS)*	PR41B	2	RDQ41	C (LVDS)*
K19	PR22A	2	RDQS22	T (LVDS)*	PR41A	2	RDQS41	T (LVDS)*
G22	PR21B	2	RDQ22	C	PR40B	2	RDQ41	C
GNDIO	GNDIO2	-			GNDIO2	-		
F22	PR21A	2	RDQ22	T	PR40A	2	RDQ41	T
J17	PR20B	2	RDQ22	C (LVDS)*	PR39B	2	RDQ41	C (LVDS)*
J18	PR20A	2	RDQ22	T (LVDS)*	PR39A	2	RDQ41	T (LVDS)*
K20	PR19B	2	RDQ22	C	PR38B	2	RDQ41	C
VCCIO	VCCIO2	2			VCCIO	2		
J19	PR19A	2	RDQ22	T	PR38A	2	RDQ41	T
H21	PR18B	2	RDQ22	C (LVDS)*	PR37B	2	RDQ41	C (LVDS)*
G21	PR18A	2	RDQ22	T (LVDS)*	PR37A	2	RDQ41	T (LVDS)*
-	-	-			GNDIO2	-		
-	-	-			VCCIO	2		
H17	NC	-			PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C
H16	NC	-			PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T
H20	NC	-			PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C
H18	NC	-			PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T
-	-	-			GNDIO2	-		
-	-	-			VCCIO	2		
F21	PR17B	2	RDQ14	C	PR19B	2	RDQ16	C
GNDIO	GNDIO2	-			GNDIO2	-		
E22	PR17A	2	RDQ14	T	PR19A	2	RDQ16	T
D22	PR16B	2	RDQ14	C (LVDS)*	PR18B	2	RDQ16	C (LVDS)*
E21	PR16A	2	RDQ14	T (LVDS)*	PR18A	2	RDQ16	T (LVDS)*
G20	PR15B	2	RDQ14	C	PR17B	2	RDQ16	C
VCCIO	VCCIO2	2			VCCIO	2		
F20	PR15A	2	RDQ14	T	PR17A	2	RDQ16	T
H19	PR14B	2	RDQ14	C (LVDS)*	PR16B	2	RDQ16	C (LVDS)*
G19	PR14A	2	RDQS14	T (LVDS)*	PR16A	2	RDQS16	T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D4	PT7B	0		C	PT7B	0		C
D3	PT7A	0		T	PT7A	0		T
C2	PT6B	0		C	PT6B	0		C
C1	PT6A	0		T	PT6A	0		T
G8	PT5B	0		C	PT5B	0		C
GND	GNDIO0	-			GNDIO0	-		
G7	PT5A	0		T	PT5A	0		T
E7	PT4B	0		C	PT4B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
F7	PT4A	0		T	PT4A	0		T
E6	PT3B	0		C	PT3B	0		C
E5	PT3A	0		T	PT3A	0		T
G6	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
G5	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T
L12	VCC	-			VCC	-		
L13	VCC	-			VCC	-		
L14	VCC	-			VCC	-		
L15	VCC	-			VCC	-		
M11	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M15	VCC	-			VCC	-		
M16	VCC	-			VCC	-		
N11	VCC	-			VCC	-		
N16	VCC	-			VCC	-		
P11	VCC	-			VCC	-		
P16	VCC	-			VCC	-		
R11	VCC	-			VCC	-		
R12	VCC	-			VCC	-		
R15	VCC	-			VCC	-		
R16	VCC	-			VCC	-		
T12	VCC	-			VCC	-		
T13	VCC	-			VCC	-		
T14	VCC	-			VCC	-		
T15	VCC	-			VCC	-		
D11	VCCIO0	0			VCCIO0	0		
D6	VCCIO0	0			VCCIO0	0		
G9	VCCIO0	0			VCCIO0	0		
K12	VCCIO0	0			VCCIO0	0		
J12	VCCIO0	0			VCCIO0	0		
D16	VCCIO1	1			VCCIO1	1		
D21	VCCIO1	1			VCCIO1	1		
G18	VCCIO1	1			VCCIO1	1		
J15	VCCIO1	1			VCCIO1	1		
K15	VCCIO1	1			VCCIO1	1		
F23	VCCIO2	2			VCCIO2	2		
J20	VCCIO2	2			VCCIO2	2		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
VCCIO	VCCIO7	7		
F4	PL2A	7	VREF2_7	T (LVDS)*
F3	PL2B	7	VREF1_7	C (LVDS)*
H4	PL3A	7		T
G5	PL3B	7		C
GND	GNDIO7	-		
D2	PL4A	7		T (LVDS)*
D1	PL4B	7		C (LVDS)*
E2	PL5A	7		T
VCCIO	VCCIO7	7		
E1	PL5B	7		C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
F1	PL14A	7	LUM1_SPLLT_IN_A/LDQ12	T (LVDS)*
F2	PL14B	7	LUM1_SPLLC_IN_A/LDQ12	C (LVDS)*
G1	PL15A	7	LUM1_SPLLT_FB_A/LDQ12	T
G2	PL15B	7	LUM1_SPLLC_FB_A/LDQ12	C
GND	GNDIO7	-		
H8	PL18A	7	LDQ21	T
H6	PL18B	7	LDQ21	C
VCCIO	VCCIO7	7		
G4	PL19A	7	LDQ21	T (LVDS)*
G3	PL19B	7	LDQ21	C (LVDS)*
H7	PL20A	7	LDQ21	T
H5	PL20B	7	LDQ21	C
GND	GNDIO7	-		
H2	PL21A	7	LDQS21	T (LVDS)*
H1	PL21B	7	LDQ21	C (LVDS)*
J6	PL22A	7	LDQ21	T
VCCIO	VCCIO7	7		
J8	PL22B	7	LDQ21	C
J2	PL23A	7	LDQ21	T (LVDS)*
J1	PL23B	7	LDQ21	C (LVDS)*
J5	PL24A	7	LDQ21	T
GND	GNDIO7	-		
J7	PL24B	7	LDQ21	C
J4	PL25A	7	LDQ29	T (LVDS)*
J3	PL25B	7	LDQ29	C (LVDS)*
K6	PL26A	7	LDQ29	T
K8	PL26B	7	LDQ29	C
VCCIO	VCCIO7	7		
K2	PL27A	7	LDQ29	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R19	GND	-		
R20	GND	-		
T11	GND	-		
T12	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T19	GND	-		
T20	GND	-		
U11	GND	-		
U12	GND	-		
U13	GND	-		
U14	GND	-		
U15	GND	-		
U16	GND	-		
U17	GND	-		
U18	GND	-		
U19	GND	-		
U20	GND	-		
V12	GND	-		
V13	GND	-		
V14	GND	-		
V15	GND	-		
V16	GND	-		
V17	GND	-		
V18	GND	-		
V19	GND	-		
V28	GND	-		
V3	GND	-		
W12	GND	-		
W13	GND	-		
W14	GND	-		
W15	GND	-		
W16	GND	-		
W17	GND	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	Ind	20
LFE2-20SE-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	Ind	20
LFE2-20SE-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	Ind	20
LFE2-20SE-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	Ind	20
LFE2-20SE-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	Ind	20
LFE2-20SE-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	Ind	20
LFE2-20SE-5FN672I	402	1.2V	-5	Lead-Free fpBGA	672	Ind	20
LFE2-20SE-6FN672I	402	1.2V	-6	Lead-Free fpBGA	672	Ind	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	Ind	35
LFE2-35SE-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	Ind	35
LFE2-35SE-5FN672I	450	1.2V	-5	Lead-Free fpBGA	672	Ind	35
LFE2-35SE-6FN672I	450	1.2V	-6	Lead-Free fpBGA	672	Ind	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5FN484I	339	1.2V	-5	Lead-Free fpBGA	484	Ind	50
LFE2-50SE-6FN484I	339	1.2V	-6	Lead-Free fpBGA	484	Ind	50
LFE2-50SE-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	Ind	50
LFE2-50SE-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	Ind	70
LFE2-70SE-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	Ind	70
LFE2-70SE-5FN900I	583	1.2V	-5	Lead-Free fpBGA	900	Ind	70
LFE2-70SE-6FN900I	583	1.2V	-6	Lead-Free fpBGA	900	Ind	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	COM	100
LFE2M100E-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	COM	100
LFE2M100E-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	COM	100
LFE2M100E-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	COM	100
LFE2M100E-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	COM	100
LFE2M100E-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	COM	100

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5FN484I	304	1.2V	-5	Lead-Free fpBGA	484	IND	20
LFE2M20E-6FN484I	304	1.2V	-6	Lead-Free fpBGA	484	IND	20
LFE2M20E-5FN256I	140	1.2V	-5	Lead-Free fpBGA	256	IND	20
LFE2M20E-6FN256I	140	1.2V	-6	Lead-Free fpBGA	256	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5FN672I	410	1.2V	-5	Lead-Free fpBGA	672	IND	35
LFE2M35E-6FN672I	410	1.2V	-6	Lead-Free fpBGA	672	IND	35
LFE2M35E-5FN484I	303	1.2V	-5	Lead-Free fpBGA	484	IND	35
LFE2M35E-6FN484I	303	1.2V	-6	Lead-Free fpBGA	484	IND	35
LFE2M35E-5FN256I	140	1.2V	-5	Lead-Free fpBGA	256	IND	35
LFE2M35E-6FN256I	140	1.2V	-6	Lead-Free fpBGA	256	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5FN900I	410	1.2V	-5	Lead-Free fpBGA	900	Ind	50
LFE2M50E-6FN900I	410	1.2V	-6	Lead-Free fpBGA	900	Ind	50
LFE2M50E-5FN672I	372	1.2V	-5	Lead-Free fpBGA	672	Ind	50
LFE2M50E-6FN672I	372	1.2V	-6	Lead-Free fpBGA	672	Ind	50
LFE2M50E-5FN484I	270	1.2V	-5	Lead-Free fpBGA	484	Ind	50
LFE2M50E-6FN484I	270	1.2V	-6	Lead-Free fpBGA	484	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5FN1152I	436	1.2V	-5	Lead-Free fpBGA	1152	Ind	70
LFE2M70E-6FN1152I	436	1.2V	-6	Lead-Free fpBGA	1152	Ind	70
LFE2M70E-5FN900I	416	1.2V	-5	Lead-Free fpBGA	900	Ind	70
LFE2M70E-6FN900I	416	1.2V	-6	Lead-Free fpBGA	900	Ind	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	100
LFE2M100SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	100
LFE2M100SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	100